

# Description

The SiT3342 is a ruggedized 1 MHz to 220 MHz differential MEMS VCXO with a maximum acceleration sensitivity of 0.1 ppb/g, engineered for low-jitter applications. Utilizing SiTime's unique DualMEMS<sup>®</sup> temperature sensing and TurboCompensation<sup>®</sup> technology, the SiT3342 delivers exceptional dynamic performance by providing resistance to airflow, thermal gradients, shock and vibration. This device also integrates multiple on-chip regulators to filter power supply noise, eliminating the need for a dedicated external LDO.

The SiT3342 can be factory programmed for any combination of frequency, stability, voltage, output signaling, and pull range. Programmability enables designers to optimize clock configurations while eliminating long lead times and customization costs associated with quartz devices where each frequency is custom built.

Refer to Manufacturing Notes for proper reflow profile, tape and reel dimension, and other manufacturing related information.

### Features

- Best acceleration sensitivity of 0.1 ppb/g
- Any frequency between 1 MHz and 220 MHz accurate to 6 decimal places
- Widest pull range options: ±25, ±50, ±80, ±100, ±150, ±200, ±400, ±800, ±1600, ±3200 ppm
- 0.225 ps RMS phase jitter (typ) over 12 kHz to 20 MHz bandwidth
- Frequency stability as low as ±15 ppm
- Wide temperature range support from -40°C to 105°C
- Industry-standard packages: 7.0 x 5.0 mm, 5.0 x 3.2 mm, 3.2 x 2.5 mm packages

# **Applications**

- Airborne Communications
- Command and Control
- Field Communications
- Airframe/Engine Management Control
- Avionics
- Satellite Base Stations/GNSS
- Telemetry



# Block Diagram

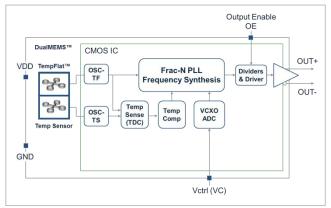


Figure 1. SiT3342 Block Diagram

### 3.2 x 2.5 mm Package Pinout

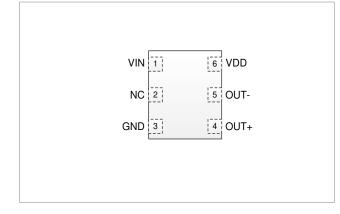
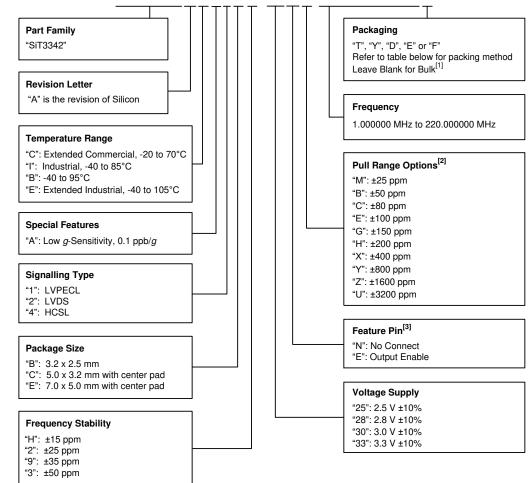


Figure 2. Pin Assignments (Top view) (Refer to Table 6 for Pin Descriptions)



# **Ordering Information**

SiT3342AEA1B2-33NH122.123456T



#### Notes:

- 1. Bulk is available for sampling only, (up to 24 u).
- 2. Contact SiTime for custom pull range options.
- 3. "E": Output Enable function is only available in 7.0 x 5.0 mm and 5.0 x 3.2 mm packages.

#### Table 1. Ordering Codes for Supported Tape & Reel Packing Method

| Device Size<br>(mm x mm) | 8 mm T&R<br>(3 ku) | 8 mm T&R<br>(1 ku) | 12 mm T&R<br>(3 ku) | 12 mm T&R<br>(1 ku) | 12 mm T&R<br>(<250 u) | 16 mm T&R<br>(3 ku) | 16 mm T&R<br>(1 ku) |
|--------------------------|--------------------|--------------------|---------------------|---------------------|-----------------------|---------------------|---------------------|
| 7.0 x 5.0                | —                  | —                  | —                   | —                   | _                     | Т                   | Y                   |
| 5.0 x 3.2                | —                  | —                  | т                   | Y                   | F                     | —                   | _                   |
| 3.2 x 2.5                | D                  | E                  | _                   | —                   | _                     | —                   | _                   |



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# **Electrical Characteristics**

### Table 2. Electrical Characteristics – Common to LVPECL, LVDS and HCSL

All Min and Max limits in the Electrical Characteristics tables are specified over temperature and rated operating voltage with standard output termination shown in the termination diagrams. Typical values are at 25°C and nominal supply voltage.

| •   |         | -        | • •                               |             |             |  |
|---|---------|----------|-----------------------------------|-------------|-------------|--|
| Parameter                                     | Symbol  | Min.     | Тур.                              | Max.        | Unit        | Condition  |
|   |         |          |                                   | Frequency   | Range       |  |
| Output Frequency Range                        | f       | 1        | -                                 | 220         | MHz         | Accurate to 6 decimal places   |
|   |         |          | F                                 | Frequency S | Stability   |  |
| Frequency Stability                           | F_stab  | -15      | -                                 | +15         | ppm         | Inclusive of initial tolerance, operating temperature, rated power   |
|   |         | -25      | -                                 | +25         | ppm         | supply voltage, load variations, and first year aging at 25°C, with VIN voltage at Vdd/2.  |
|   |         | -35      | -                                 | +35         | ppm         | $\pm 15$ ppm is only guaranteed for pull range up to $\pm 100$ ppm.  |
|   |         | -50      | -                                 | +50         | ppm         |  |
|   |         |          | 1                                 | [emperature | e Range     |  |
| Operating Temperature Range                   | T_use   | -20      | -                                 | +70         | °C          | Extended Commercial  |
|   |         | -40      | -                                 | +85         | °C          | Industrial   |
|   |         | -40      | -                                 | +95         | °C          |  |
|   |         | -40      | -                                 | +105        | °C          | Extended Industrial  |
|   |         |          | Ru                                | gged Chara  | acteristics |  |
| Acceleration (g) sensitivity,<br>Gamma Vector | F_g     | -        | -                                 | 0.1         | ppb/g       | Low sensitivity grade; total gamma over 3 axes; 15 Hz to 2 kHz;<br>MIL-PRF-55310, computed per section 4.8.18.3.1  |
|   |         |          |                                   | Supply Vo   | oltage      |  |
| Supply Voltage                                | Vdd     | 2.97     | 3.3                               | 3.63        | V           |  |
|   |         | 2.7      | 3.0                               | 3.3         | V           |  |
|   |         | 2.52     | 2.8                               | 3.08        | V           |  |
|   |         | 2.25     | 2.5                               | 2.75        | V           |  |
|   |         |          | Voltag                            | e Control C | haracterist | ics  |
| Pull Range                                    | PR      |          | 0, ±80, ±10<br>400, ±800<br>±3200 |             | ppm         | See the APR (Absolute Pull Range) Table 11.<br>Contact SiTime for custom pull range options  |
| Upper Control Voltage                         | VC U    | 90%      | _                                 | -           | Vdd         | Voltage at which maximum frequency deviation is guaranteed   |
| Lower Control Voltage                         | VC_L    | _        | _                                 | 10%         | Vdd         | Voltage at which minimum frequency deviation is guaranteed   |
| Control Voltage Input Impedance               | VC z    | -        | 10                                | -           | MΩ          |  |
| Control Voltage Input Bandwidth               | V c     | -        | 10                                | -           | kHz         | Contact SiTime for other input bandwidth options   |
| Pull Range Linearity                          | Lin     | _        | _                                 | 1.0         | %           |  |
| Frequency Change Polarity                     | -       | Positive | e Slope                           |             | _           |  |
|   |         |          | In                                | put Charac  | teristics   | ·  |
| Input Voltage High                            | VIH     | 70%      | -                                 | -           | Vdd         | Pin 2, OE  |
| Input Voltage Low                             | VIL     | _        | -                                 | 30%         | Vdd         | Pin 2, OE  |
| Input Pull-up Impedance                       | Z_in    | -        | 100                               | -           | kΩ          | Pin 2, OE logic high or logic low  |
|   |         | •        | Ou                                | tput Chara  | cteristics  | ·  |
| Duty Cycle                                    | DC      | 45       | -                                 | 55          | %           |  |
|   |         |          | Sta                               | artup and C | DE Timing   |  |
| Startup Time                                  | T_start | -        | -                                 | 3.0         | ms          | Measured from the time Vdd reaches its rated minimum value   |
| OE Enable/Disable Time                        | T_oe    | -        | -                                 | 3.8         | μs          | f = 156.25 MHz. Measured from the time OE pin reaches<br>rated VIH and VIL to the time clock pins reach 90% of swing<br>and high-Z. See Figure 9 and Figure 10 |
|   |         |          |                                   |             |             | •  |



# Table 3. Electrical Characteristics – LVPECL Specific

| Parameter                         | Symbol   | Min.     | Тур.       | Max.          | Unit        | Condition  |
|-----------------------------------|----------|----------|------------|---------------|-------------|--|
|                                   |          |          |            | Irrent Cons   |             |  |
| Current Consumption               | ldd      | _        | 78         | 92            | mA          | Excluding Load Termination Current, Vdd = 3.3 V or 2.5 V   |
| OE Disable Supply Current         | I_OE     | -        | 53         | 61            | mA          | OE = Low   |
| Output Disable Leakage Current    | I_leak   | -        | 0.15       | -             | μA          | OE = Low   |
| Maximum Output Current            | I_driver | -        | -          | 33            | mA          | Maximum average current drawn from OUT+ or OUT-  |
|                                   | •        |          | Ou         | tput Chara    | cteristics  | ·  |
| Output High Voltage               | VOH      | Vdd-1.15 | -          | Vdd-0.7       | V           | See Figure 5   |
| Output Low Voltage                | VOL      | Vdd-2.0  | -          | Vdd-1.5       | V           | See Figure 5   |
| Output Differential Voltage Swing | V_Swing  | 1.2      | 1.6        | 2.0           | V           | See Figure 6   |
| Rise/Fall Time                    | Tr, Tf   | -        | 225        | 290           | ps          | 20% to 80%, see Figure 6   |
|                                   |          |          | Jitter     | – 7.0 x 5.0 r | nm packag   | ge   |
| RMS Period Jitter <sup>[4]</sup>  | T_jitt   | -        | 1.0        | 1.6           | ps          | f = 100, 156.25 or 212.5 MHz, Vdd = 3.3 V or 2.5 V   |
| RMS Phase Jitter (random)         | T_phj    | -        | 0.225      | 0.270         | ps          | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdd levels, includes spurs, pull range = ±100 ppm. Temperature ranges -20 to 70°C and -40 to 85°C        |
|                                   |          | -        | 0.225      | 0.300         | ps          | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all<br>Vdd levels, includes spurs, pull range = ±100 ppm. Temperature<br>ranges -40 to 95°C and -40 to 105°C |
|                                   |          | -        | 0.1        | -             | ps          | f = 156.25 MHz, IEEE802.3-2005 10 GbE jitter mask integration<br>bandwidth = 1.875 MHz to 20 MHz, includes spurs, all Vdd<br>levels                                    |
|                                   |          | Jitter   | – 5.0 x 3. | 2 mm and 3    | .2 x 2.5 mi | m package  |
| RMS Period Jitter <sup>[4]</sup>  | T_jitt   | -        | 1.0        | 1.6           | ps          | f = 100, 156.25 or 212.5 MHz, Vdd = 3.3 V or 2.5 V   |
| RMS Phase Jitter (random)         | T_phj    | -        | 0.225      | 0.275         | ps          | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all<br>Vdd levels, includes spurs, pull range = ±100 ppm. Temperature<br>ranges -20 to 70°C and -40 to 85°C  |
|                                   |          | -        | 0.225      | 0.340         | ps          | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdd levels, includes spurs, pull range = $\pm 100$ ppm. Temperature ranges -40 to 95°C and -40 to 105°C  |
|                                   |          | -        | 0.1        | -             | ps          | f = 156.25 MHz, IEEE802.3-2005 10 GbE jitter mask integration<br>bandwidth = 1.875 MHz to 20 MHz, includes spurs, all Vdd<br>levels                                    |

Notes: 4. Measured according to JESD65B.



### Table 4. Electrical Characteristics – LVDS

| Parameter                        | Symbol | Min.   | Тур.       | Max.          | Unit        | Condition  |
|----------------------------------|--------|--------|------------|---------------|-------------|--|
|                                  |        |        | Cı         | urrent Cons   | sumption    |  |
| Current Consumption              | Idd    | -      | 73         | 84            | mA          | Excluding Load Termination Current, Vdd = 3.3 V or 2.5 V   |
| OE Disable Supply Current        | I_OE   | -      | 55         | 62            | mA          | OE = Low   |
| Output Disable Leakage Current   | I_leak | -      | 0.15       | -             | μA          | OE = Low   |
|                                  |        |        | Ou         | tput Chara    | cteristics  |  |
| Differential Output Voltage      | VOD    | 250    | -          | 450           | mV          | See Figure 7   |
| Delta VOD                        | ΔVOD   | I      | -          | 50            | mV          | See Figure 7   |
| Offset Voltage                   | VOS    | 1.125  | -          | 1.375         | V           | See Figure 7   |
| Delta VOS                        | ΔVOS   | -      | -          | 50            | mV          | See Figure 7   |
| Rise/Fall Time                   | Tr, Tf | Ι      | 400        | 470           | ps          | Measured with 2 pF capacitive loading to GND, 20% to 80%, see Figure 8   |
|                                  |        |        | Jitter     | – 7.0 x 5.0 i | mm packaç   | ge   |
| RMS Period Jitter <sup>[5]</sup> | T_jitt | I      | 1.0        | 1.6           | ps          | f = 100, 156.25 or 212.5 MHz, Vdd = 3.3 V or 2.5 V   |
| RMS Phase Jitter (random)        | T_phj  | -      | 0.215      | 0.265         | ps          | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdd levels, includes spurs, pull range = $\pm$ 100 ppm.<br>Temperature ranges -20 to 70°C and -40 to 85°C  |
|                                  |        | -      | 0.215      | 0.300         | ps          | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all<br>Vdd levels, includes spurs, pull range = ±100 ppm.<br>Temperature ranges -40 to 95°C and -40 to 105°C   |
|                                  |        | -      | 0.1        | -             | ps          | f = 156.25 MHz, IEEE802.3-2005 10 GbE jitter mask integration<br>bandwidth = 1.875 MHz to 20 MHz, includes spurs, all Vdd<br>levels                                      |
|                                  |        | Jitter | – 5.0 x 3. | 2 mm and 3    | 3.2 x 2.5 m | m package  |
| RMS Period Jitter <sup>[5]</sup> | T_jitt | I      | 1.0        | 1.6           | ps          | f = 100, 156.25 or 212.5 MHz, Vdd = 3.3 V or 2.5 V   |
| RMS Phase Jitter (random)        | T_phj  | -      | 0.235      | 0.275         | ps          | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdd levels, includes spurs, pull range = $\pm 100$ ppm.<br>Temperature ranges -20 to 70°C and -40 to 85°C  |
|                                  |        | -      | 0.235      | 0.320         | ps          | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdd levels, includes spurs, pull range = $\pm 100$ ppm.<br>Temperature ranges -40 to 95°C and -40 to 105°C |
|                                  |        | -      | 0.1        | -             | ps          | f = 156.25 MHz, IEEE802.3-2005 10 GbE jitter mask integration<br>bandwidth = 1.875 MHz to 20 MHz, includes spurs, all Vdd<br>levels                                      |

Notes: 5. Measured according to JESD65B.



### Table 5. Electrical Characteristics – HCSL

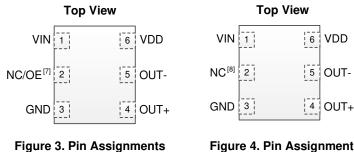
| Parameter                         | Symbol  | Min.   | Тур.       | Max.          | Unit        | Condition  |
|-----------------------------------|---------|--------|------------|---------------|-------------|--|
|                                   | eymoor  |        |            | urrent Cons   |             | Condition  |
| Current Consumption               | ldd     | _      | 83         | 97            | mA          | Excluding Load Termination Current, Vdd = 3.3 V or 2.5 V   |
| OE Disable Supply Current         | I OE    | _      | 55         | 62            | mA          | OE = Low   |
| Output Disable Leakage Current    | l leak  | _      | 0.15       | _             | μA          | OE = Low   |
|                                   | _       |        | Ou         | Itput Chara   | cteristics  |  |
| Output High Voltage               | VOH     | 0.60   | _          | 0.90          | V           | See Figure 5   |
| Output Low Voltage                | VOL     | -0.05  | _          | 0.08          | V           | See Figure 5   |
| Output Differential Voltage Swing | V_Swing | 1.2    | 1.4        | 1.80          | V           | See Figure 6   |
| Rise/Fall Time                    | Tr, Tf  | -      | 360        | 495           | ps          | Measured with 2 pF capacitive loading to GND, 20% to 80%, See Figure 6   |
|                                   |         |        | Jitter     | - 7.0 x 5.0 i | mm packag   | ge   |
| RMS Period Jitter <sup>[6]</sup>  | T_jitt  | -      | 1.0        | 1.6           | ps          | f = 100, 156.25 or 212.5 MHz, Vdd = 3.3 V or 2.5 V   |
| RMS Phase Jitter (random)         | T_phj   | -      | 0.220      | 0.270         | ps          | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all<br>Vdd levels, includes spurs, pull range = ±100 ppm.<br>Temperature ranges -20 to 70°C and -40 to 85°C  |
|                                   |         | -      | 0.220      | 0.300         | ps          | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all<br>Vdd levels, includes spurs, pull range = ±100 ppm.<br>Temperature ranges -40 to 95°C and -40 to 105°C |
|                                   |         | -      | 0.1        | -             | ps          | f = 156.25 MHz, IEEE802.3-2005 10 GbE jitter mask integration<br>bandwidth = 1.875 MHz to 20 MHz, includes spurs, all Vdd<br>levels                                    |
|                                   |         | Jitter | – 5.0 x 3. | 2 mm and 3    | 3.2 x 2.5 m | m package  |
| RMS Period Jitter <sup>[6]</sup>  | T_jitt  | -      | 1.0        | 1.6           | ps          | f = 100, 156.25 or 212.5 MHz, Vdd = 3.3 V or 2.5 V   |
| RMS Phase Jitter (random)         | T_phj   | -      | 0.230      | 0.275         | ps          | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdd levels, includes spurs, pull range = ±100 ppm.<br>Temperature ranges -20 to 70°C and -40 to 85°C     |
|                                   |         | -      | 0.230      | 0.340         | ps          | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdd levels, includes spurs, pull range = ±100 ppm.<br>Temperature ranges -40 to 95°C and -40 to 105°C    |
|                                   |         | -      | 0.1        | -             | ps          | f = 156.25 MHz, IEEE802.3-2005 10 GbE jitter mask integration<br>bandwidth = 1.875 MHz to 20 MHz, includes spurs, all Vdd<br>levels                                    |

Notes:

6. Measured according to JESD65B.

#### Table 6. Pin Description

| Pin | Symbol             | Functionality         |   |  |  |  |
|-----|--------------------|-----------------------|---|--|--|--|
| 1   | VIN                | Input                 | Control Voltage   |  |  |  |
|     | No Connect<br>(NC) |                       | No Connect: Leave floating or connect to GND for better heat dissipation.<br>NC for all 3.2 x 2.5 mm package options.   |  |  |  |
| 2   |                    | Output Enable<br>(OE) | H <sup>[7,8]</sup> : specified frequency output<br>L: output is high impedance. Only output driver is disabled.<br>OE function only available on 7050 package. Pin 2 on 3225 package is NC. |  |  |  |
| 3   | GND                | Power                 | Vdd Power Supply Ground   |  |  |  |
| 4   | OUT+               | Output                | Oscillator output   |  |  |  |
| 5   | OUT-               | Output                | Complementary oscillator output   |  |  |  |
| 6   | VDD                | Power                 | Power supply voltage <sup>[9]</sup>   |  |  |  |



### (7.0 x 5.0 mm and 5.0 x 3.2 mm packages)

#### Figure 4. Pin Assignments (3.2 x 2.5 mm package)

#### Notes:

7. A pull-up resistor of 10  $k\Omega$  or less is recommended if pin 1 is not externally driven.

8. OE mode is only available in the 7050 and 5032 packages. 3225 package is NC.

9. A capacitor of value 0.1 µF or higher between VDD and GND is required. An additional 10 µF capacitor between VDD and GND is required for the best phase jitter performance.



### Table 7. Absolute Maximum Ratings

Attempted operation outside the absolute maximum ratings may cause permanent damage to the part.

Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

| Parameter  | Min. | Max.        | Unit |
|--|------|-------------|------|
| Continuous Power Supply Voltage Range (Vdd)                          | -0.5 | 4.0         | V    |
| Input Voltage, Maximum (any input pin)                               |      | Vdd + 0.3 V | V    |
| Input Voltage, Minimum (any input pin)                               | -0.3 |             | V    |
| Storage Temperature  | -65  | 150         | °C   |
| Maximum Junction Temperature   |      | 145         | °C   |
| Soldering Temperature (follow standard Pb-free soldering guidelines) |      | 260         | °C   |

### Table 8. Thermal Considerations<sup>[10]</sup>

| Package     | $	heta_{	extsf{JA}}$ , 4 Layer Board (°C/W) | θ <sub>JC</sub> , Bottom (°C/W) |
|-------------|---|---------------------------------|
| 3225, 6-pin | 80  | 30                              |
| 5032, 6-pin | 53[11]                                      | 20                              |
| 7050, 6-pin | 52 <sup>[11]</sup>                          | 19                              |

Notes:

10. Refer to JESD51 for  $\theta_{JA}$  and  $\theta_{JC}$  definitions, and reference layout used to determine the  $\theta_{JA}$  and  $\theta_{JC}$  values in the above table.

11. Value for  $\theta_{JA}$  assumes the center pad is soldered down.

#### Table 9. Maximum Operating Junction Temperature<sup>[12]</sup>

| Max Operating Temperature (ambient) | Maximum Operating Junction Temperature:<br>3225 Package | Maximum Operating Junction Temperature:<br>5032, 7050 Packages |
|-------------------------------------|---|--|
| 70°C                                | 105°C   | 95°C   |
| 85°C                                | 130°C   | 110°C  |
| 95°C                                | 130°C   | 120°C  |
| 105°C                               | 145°C   | 130°C  |

Notes:

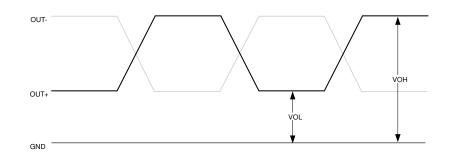
12. Datasheet specifications are not guaranteed if junction temperature exceeds the maximum operating junction temperature.

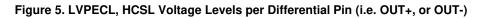
#### **Table 10. Environmental Compliance**

| Parameter  | Test Conditions           | Value  | Unit |  |
|--|---------------------------|--------|------|--|
| Mechanical Shock Resistance  | MIL-STD-883F, Method 2002 | 10,000 | g    |  |
| Mechanical Vibration Resistance                                      | MIL-STD-883F, Method 2007 | 70     | g    |  |
| Soldering Temperature (follow standard Pb free soldering guidelines) | MIL-STD-883F, Method 2003 | 260    | °C   |  |
| Moisture Sensitivity Level   | MSL1 @ 260°C              |        |      |  |
| Electrostatic Discharge (HBM)  | HBM, JESD22-A114          | 2,000  | V    |  |
| Charge-Device Model ESD Protection                                   | JESD220C101               | 750    | V    |  |
| Latch-up Tolerance   | JESD78 Compliant          |        |      |  |



# **Waveform Diagrams**





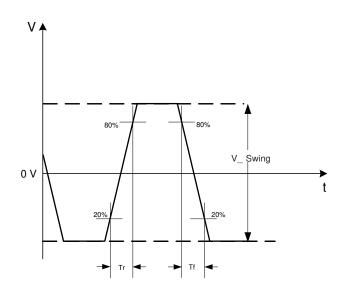


Figure 6. LVPECL, HCSL Voltage Levels across Differential Pair (i.e. OUT+ minus OUT-)



# Waveform Diagrams (continued)

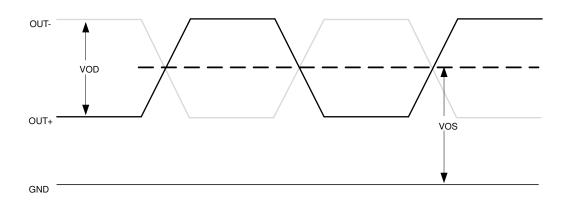


Figure 7. LVDS Voltage Levels per Differential Pin (OUT+, or OUT-)

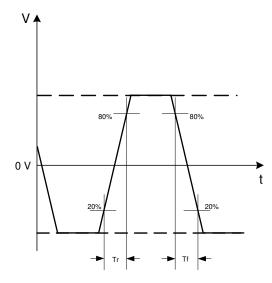
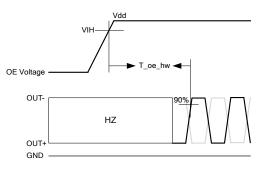
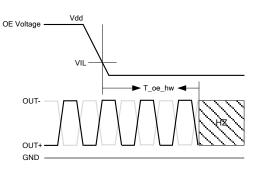


Figure 8. LVDS Differential Waveform (i.e. OUT+ minus OUT-)

# **Timing Diagrams**





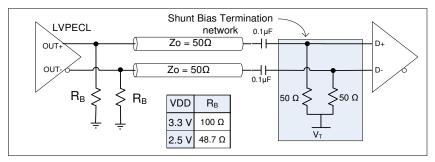


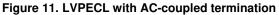




# **Termination Diagrams**

### LVPECL





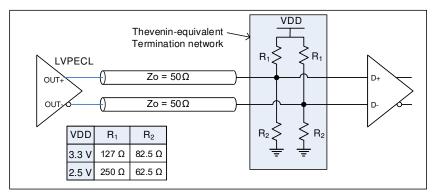


Figure 12. LVPECL DC-coupled load termination with Thevenin equivalent network

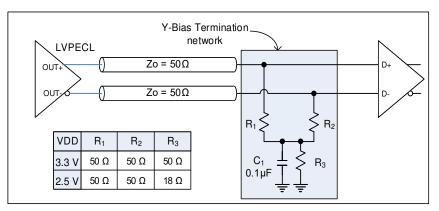


Figure 13. LVPECL with Y-Bias termination

### LVPECL (continued)

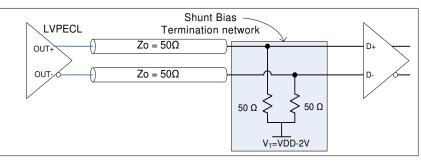


Figure 14. LVPECL with DC-coupled parallel shunt load termination



### **Termination Diagrams** (continued)

### LVDS

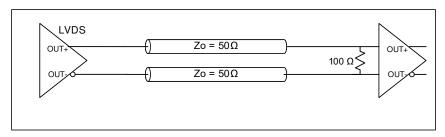
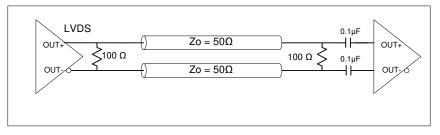


Figure 15. LVDS single DC termination at the load





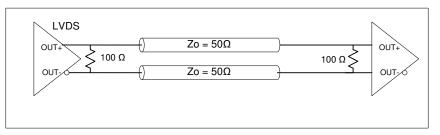


Figure 17. LVDS double DC termination

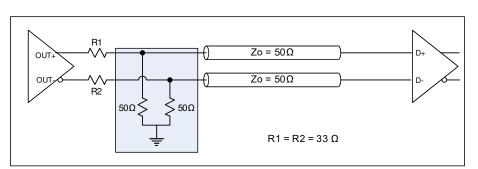
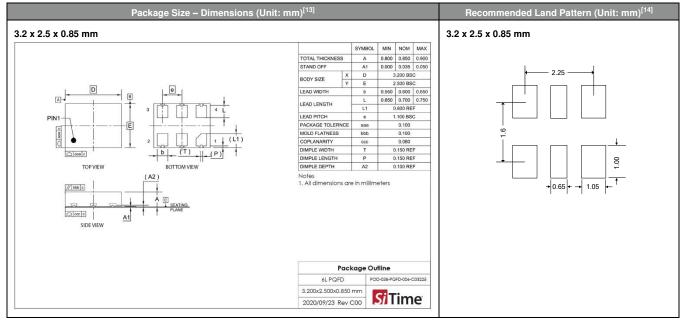


Figure 18. HCSL interface termination

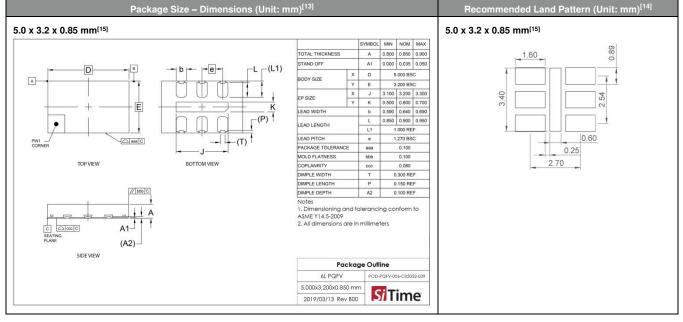
HCSL



### Dimensions and Patterns — 3.2 x 2.5 mm



# Dimensions and Patterns — 5.0 x 3.2 mm

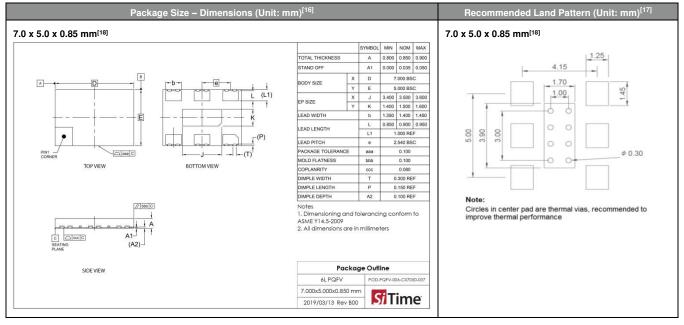


Notes:

- 13. Top Marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of "Y" will depend on the assembly location of the device.
- A capacitor of value 0.1 μF or higher between VDD and GND is required. An additional 10 μF capacitor between VDD and GND is required for the best phase jitter performance.
- 15. The center pad is internally connected to the GND pin. Soldering down the center pad to the GND is recommended for best thermal dissipation, but is optional.



# Dimensions and Patterns — 7.0 x 5.0 mm



#### Notes:

16. Top Marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of "Y" will depend on the assembly location of the device.

17. A capacitor of value 0.1 µF or higher between VDD and GND is required. An additional 10 µF capacitor between VDD and GND is required for the best phase jitter performance.

18. The center pad is internally connected to the GND pin. Soldering down the center pad to the GND is recommended for best thermal dissipation, but is optional.



### Table 11. APR Table

Absolute pull range (APR) = Nominal pull range (PR) - frequency stability (F\_stab)-aging<sup>[19]</sup>

|                    | Frequency Stability |        |        |        |  |  |  |  |
|--------------------|---------------------|--------|--------|--------|--|--|--|--|
| Nominal Pull Range | ± 15                | ± 25   | ± 35   | ± 50   |  |  |  |  |
|                    | APR (ppm)           |        |        |        |  |  |  |  |
| ± 25               | ± 5                 | -      | -      | -      |  |  |  |  |
| ± 50               | ± 30                | ± 20   | ± 10   | -      |  |  |  |  |
| ± 80               | ± 60                | ± 50   | ± 40   | ± 25   |  |  |  |  |
| ± 100              | ± 80                | ± 70   | ± 60   | ± 45   |  |  |  |  |
| ± 150              | -                   | ± 120  | ± 110  | ± 95   |  |  |  |  |
| ± 200              | -                   | ± 170  | ± 160  | ± 145  |  |  |  |  |
| ± 400              | -                   | ± 370  | ± 360  | ± 345  |  |  |  |  |
| ± 800              | -                   | ± 770  | ± 760  | ± 745  |  |  |  |  |
| ± 1600             | -                   | ± 1570 | ± 1560 | ± 1545 |  |  |  |  |
| ± 3200             | _                   | ± 3170 | ± 3160 | ± 3145 |  |  |  |  |

Note: 19. Aging includes solder down shift and 20-year aging.

# **Additional Information**

### Table 12. Additional Information

| Document                                 | Description  | Download Link  |  |
|--|--|--|--|
| ECCN #: EAR99                            | Five character designation used on the commerce<br>Control List (CCL) to identify dual use items for export<br>control purposes.           | trol List (CCL) to identify dual use items for export  |  |
| HTS Classification Code:<br>8542.39.0000 | A Harmonized Tariff Schedule (HTS) code developed by<br>the World Customs Organization to classify/define<br>internationally traded goods. | _  |  |
| Part number Generator                    | Tool used to create the part number based on desired features.   | https://www.sitime.com/part-number-generator   |  |
| Time Machine II                          | MEMS oscillator programmer   | http://www.sitime.com/support/time-machine-oscillator-programmer                                 |  |
| Manufacturing Notes                      | Tape & Reel dimension, reflow profile and other<br>manufacturing related info  | https://www.sitime.com/sites/default/files/gated/Manufacturing-<br>Notes-for-SiTime-Products.pdf |  |
| Qualification Reports                    | RoHS report, reliability reports,<br>composition reports   | http://www.sitime.com/support/quality-and-reliability  |  |
| Performance Reports                      | Additional performance data such as phase noise,<br>current consumption and jitter for selected<br>frequencies                             | http://www.sitime.com/support/performance-measurement-report                                     |  |
| Termination Techniques                   | AN10029 Termination design recommendations   | http://www.sitime.com/support/application-notes  |  |
| Layout Techniques                        | AN10006 Layout recommendations   | http://www.sitime.com/support/application-notes  |  |
| Evaluation Boards                        | SiT6085EB, SiT6086EB and SiT6097EB for Differential Oscillators  | https://www.sitime.com/support/user-guides   |  |



# **Revision History**

### Table 13. Revision History

| Revision | Release Date | Change Summary   |
|----------|--------------|--|
| 0.5      | 30-Jul-2019  | Initial draft release  |
| 1.00     | 24-Jul-2020  | Formatting updates<br>Corrected typos<br>Updated package Dimensions Drawings<br>Updated Table 8 Thermal Considerations for 5032 package<br>Added Evaluation Boards SiT6085EB reference in Additional Information<br>Rearranged layout, added Description, Block Diagram and TOC<br>Added HTS classification code<br>Clarified ±15 ppm pull range up to ±100 ppm<br>Modified maximum junction temperatures<br>Removed I_driver HCSL specification as not applicable |
| 1.01     | 17-Mar-2021  | Updated L1 and Dimple Width package dimensions for 3.2 x 2.5 mm package<br>Updated trademarks, hyperlinks and changed rev table date format  |
| 1.02     | 21-Nov-2022  | Updated Ordering packaging information with F option<br>Updated hyperlinks and icons on page 1. Disclaimer update  |

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